

MASW-010646

Rev. V6

#### **Features**

Broadband Performance, 26 to 40 GHz

Low Loss: 0.6 dBHigh Isolation: 32 dB

• Up to 13 W CW Power, +85°C

Die with G-S-G RF Pads and DC Bias Pads

Includes DC Blocks and RF Bias Networks

RoHS\* Compliant

#### **Applications**

· Aerospace & Defense

#### Description

The MASW-010646 is a high power, broadband, reflective, high linearity, SPDT switch die. This switch was developed for Ka–Band applications that require up to 13 W of power handling while maintaining low insertion loss and high isolation.

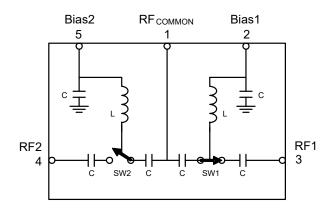
The SPDT MMIC utilizes MACOM's proven AlGaAs PIN diode technology. The switch is fully passivated with silicon nitride and has an added polymer layer for scratch protection. The protective coating prevents damage to the junction and the anode air-bridge during handling and assembly. The die has backside metallization to facilitate an epoxy die attach process.

### Ordering Information<sup>1</sup>

| Part Number        | Package            |
|--------------------|--------------------|
| MASW-010646-13940G | Die in Gel Pack    |
| MASW-010646-13940W | Die in Waffle Pack |

1. Die quantity varies.

#### **Functional Diagram**



#### Pad Configuration:

(Back Metal is RF, DC, and Thermal Ground)

| Pad # | Function             |
|-------|----------------------|
| 1     | RF <sub>COMMON</sub> |
| 2     | BIAS 1               |
| 3     | RF1                  |
| 4     | RF2                  |
| 5     | BIAS 2               |

<sup>\*</sup> Restrictions on Hazardous Substances, compliant to current RoHS EU directive.



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#### **Electrical Specifications:**

Freq. = 28 - 38 GHz,  $T_A = +25^{\circ}$ C,  $I_F^2 = +25$  mA,  $V_R^3 = -15$  V,  $Z_0 = 50$   $\Omega$ 

| Parameter  | Test Conditions  | Units | Min. | Тур.                                 | Max.                     |
|--|--|-------|------|--------------------------------------|--------------------------|
| Insertion Loss<br>(RF <sub>COMMON</sub> to RFx ON state)                                       | 26 GHz<br>28 GHz<br>35 GHz<br>38 GHz<br>40 GHz                       | dB    | _    | 0.60<br>0.60<br>0.60<br>0.60<br>0.70 | 0.90<br>0.90<br>0.90<br> |
| Isolation<br>(RF <sub>COMMON</sub> to RFx OFF state) <sup>4</sup>                              | 26 GHz<br>28 GHz<br>35 GHz<br>38 GHz<br>40 GHz                       | dB    |      | 34<br>35<br>39<br>41<br>42           | _                        |
| Return Loss<br>(RF <sub>COMMON</sub> )   | 26 GHz<br>28 GHz<br>35 GHz<br>38 GHz<br>40 GHz                       | dB    | _    | 16<br>18<br>16<br>16                 | _                        |
| Return Loss<br>(RFx ON state)  | 26 GHz<br>28 GHz<br>35 GHz<br>38 GHz<br>40 GHz                       | dB    | _    | 16<br>18<br>16<br>16                 | _                        |
| CW Power Handling (ON state) <sup>3</sup>  | -25 V, +85°C   | dBm   | _    | 41.2                                 | _                        |
| Switching Speed<br>T <sub>ON</sub> / T <sub>OFF</sub><br>T <sub>RISE</sub> / T <sub>FALL</sub> | 50% DC to 90% RF / 50% DC to 10% RF<br>10% to 90% RF / 90% to 10% RF | ns    | _    | 25 / 23<br>9 / 9                     | _                        |
| Reverse Bias Voltage <sup>3</sup>  |  | V     | -32  | -15                                  | -5                       |
| Reverse Bias Current <sup>3</sup>  | -15 V  | nA    | _    | 25                                   | _                        |

<sup>2.</sup> Forward bias current ( $I_F$ ) is set using external bias resistors ( $R_{BIAS}$ ) placed at pins Bias1 and Bias2, where  $R_{BIAS} = (V_{CC} - 1.32 \text{ V}) / I_F$ .

### **Absolute Maximum Ratings**<sup>5,6</sup>

| Parameter               | Absolute Maximum |
|-------------------------|------------------|
| DC Reverse Bias Voltage | 50 V             |
| Forward Bias Current    | 40 mA            |
| CW Incident Power       | 43 dBm @ 85°C    |
| Operating Temperature   | -40°C to +85°C   |
| Storage Temperature     | -65°C to +150°C  |

<sup>5.</sup> Exceeding any one or combination of these limits may cause permanent damage to this device.

#### **Truth Table**

| RF <sub>COMMOM</sub> Path           | Bias 1 | Bias 2 |
|-------------------------------------|--------|--------|
| RF1 Insertion Loss<br>RF2 Isolation | -15 V  | 25 mA  |
| RF2 Insertion Loss<br>RF1 Isolation | 25 mA  | -15 V  |

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<sup>3.</sup> Reverse bias voltage should be determined based on working conditions. For example, -25 V @ 41.2 dBm input power. For lower power applications, a less negative voltage can be used. R. Caverly and G. Hiller, "Establishing the Minimum Reverse Bias for a PIN Diode in a High Power Switch," IEEE Transactions on Microwave Theory and Techniques, Vol.38, No.12, December 1990.

4. Isolation defined with 1 port in low loss state.

<sup>6.</sup> MACOM does not recommend sustained operation near these survivability limits.



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#### Minimum Reverse Bias Voltage<sup>7</sup>

| Frequency (GHz) | DC Voltage (V) |
|-----------------|----------------|
| 26              | 16             |
| 30              | 14             |
| 35              | 12             |
| 40              | 11             |

Minimum DC bias voltage to maintain low loss under 41.2 dBm of power with 1.5:1 VSWR.

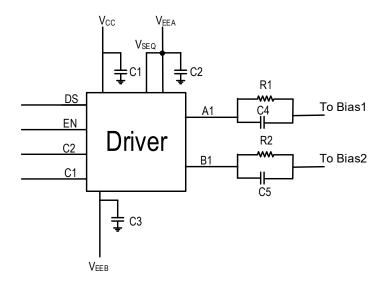
#### **Handling Procedures**

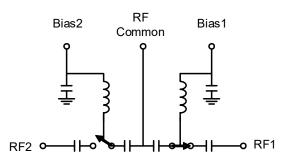
Please observe the following precautions to avoid damage:

#### **Static Sensitivity**

These electronic devices are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these HBM Class 1A devices.

#### MASW-010646 with MADR-011020 Driver Application Schematic





#### Parts List8

| Part   | Value  |
|--------|--------|
| C1, C3 | 0.1 μF |
| C2     | 47 pF  |
| C4, C5 | 470 pF |
| R1, R2 | 150 Ω  |

<sup>8.</sup> Resistor values calculated to provide 25 mA of bias current given  $V_{\text{CC}}$  = 5 V.

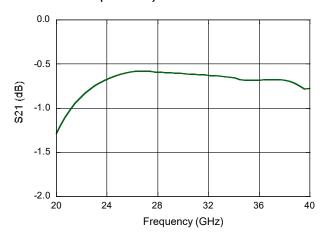


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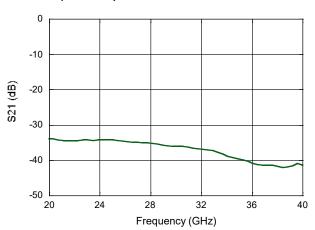
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#### Typical Performance: $T_A = +25^{\circ}C$ , +25 mA, -15 V, $Z_0 = 50 \Omega$

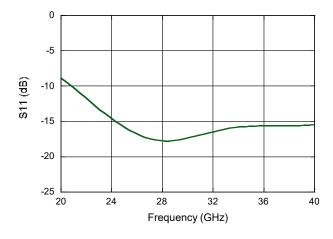
#### Insertion Loss (On State)



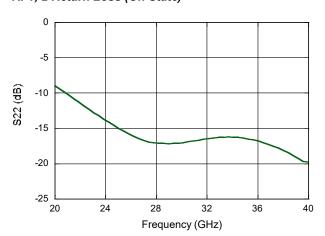
#### Isolation (Off State)



#### RF<sub>COMMON</sub> Return Loss ((On State)



#### RF1, 2 Return Loss (On State)

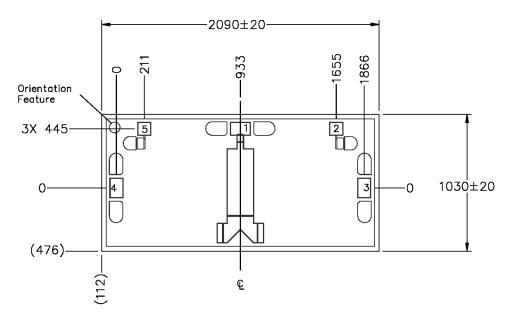




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#### Die Outline<sup>†</sup>



 $<sup>^{\</sup>dagger}$  Dimensions indicated in µm. Die Thickness : 100 µm RF Pads (1, 3 & 4) are 100 x 150 µm. DC Bias Pads (2 & 5) are 100 x 100 µm. Meets JEDEC moisture sensitivity level 1 requirements.



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